

(Top View)

SOT363

(Top View)

DFN1010

6 C

5 V_{CC}

A 1

B 3

A 1

GND 2

В

3 4

GND 2

6 C

4 Y

5 V_{CC}



SINGLE 3 INPUT POSITIVE NAND GATE

Pin Assignments

6 C

[4] Y

С

 $V_{\rm CC}$

5 V_{CC}

Description

The 74LVC1G10 is a single 3-input positive NAND gate with a standard push-pull output. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using IOFF. The IOFF circuitry disables the output preventing damaging current backflow when the device is powered down.

The gate performs the positive Boolean function:

$$Y = \overline{A \bullet B \bullet C} \quad \text{or} \quad Y = \overline{A} + \overline{B} + \overline{C}$$

Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- ± 24mA Output Drive at 3.3V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Exceeds JESD 22 200-V Machine Model (A115-A) 2000-V Human Body Model (A114-A)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- Range of Package Options
- SOT26, SOT363, DFN1410, and DFN1010: Available in "Green" Molding Compound (no Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Applications

A

B 3 4

GND

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation

(Top View)

SOT26

(Top View)

1`6

2 5

DFN1410

A₁₁

B₃

GND 2

- Wide array of products such as:
 - PCs, networking, notebooks, netbooks, PDAs
 - o Computer peripherals, hard drives, CD/DVD ROM
 - o TV, DVD, DVR, set top box
 - o Cell Phones, Personal Navigation / GPS
 - o MP3 players ,Cameras, Video Recorders

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.

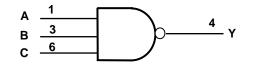


SINGLE 3 INPUT POSITIVE NAND GATE

Pin Descriptions

Pin Name	Description
A	Data Input
GND	Ground
В	Data Input
Y	Data Output
V _{CC}	Supply Voltage
С	Data Input

Logic Diagram



Function Table

	Output		
Α	В	С	Y
Н	Н	Н	L
L	Х	Х	Н
Х	L	Х	Н
Х	Х	L	Н

Absolute Maximum Ratings (Note 2)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or I _{OFF} state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V _{CC} +0.5	V
I _{IK}	Input Clamp Current VI<0	-50	mA
I _{OK}	Output Clamp Current	-50	mA
Ι _Ο	Continuous output current	±50	mA
	Continuous current through Vdd or GND	±100	mA
TJ	Operating Junction Temperature	-40 to 150	°C
T _{STG}	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.



SINGLE 3 INPUT POSITIVE NAND GATE

Recommended Operating Conditions (Note 3)

Symbol		Parameter	Min	Max	Unit
		Operating	1.65	5.5	V
V _{CC}	Operating Voltage	Data retention only	1.5		V
		V _{CC} = 1.65V to 1.95V	0.65 X V _{CC}		
		V _{CC} = 2.3V to 2.7V	1.7		
VIH	High-level Input Voltage	$V_{CC} = 3V$ to 3.6V	2		V
		$V_{CC} = 4.5V$ to 5.5V	0.7 X V _{CC}		
		V _{CC} = 1.65V to 1.95V		0.35 X V _{CC}	
Ň		V _{CC} = 2.3V to 2.7V		0.7	V
VIL	Low-level input voltage	$V_{CC} = 3V$ to 3.6V		0.8	V
		$V_{CC} = 4.5V$ to 5.5V		0.3 X V _{CC}	
VI	Input Voltage		0	5.5	V
Vo	Output Voltage		0	V _{CC}	V
		V _{CC} = 1.65V		-4	
		$V_{CC} = 2.3V$		-8	
I _{OH}	High-level output current	output current		-16	mA
		$V_{CC} = 3V$		-24	
		$V_{CC} = 4.5V$		-32	
		V _{CC} = 1.65V		4	
		$V_{CC} = 2.3V$		8	
I _{OL}	Low-level output current	$V_{CC} = 3V$		16	mA
		V _{CC} = 3V		24	
		$V_{CC} = 4.5V$		32	
	lanut transition visa f-1	$V_{CC} = 1.8V \pm 0.15V, 2.5V \pm 0.2V$		20	
Δt/ΔV	Input transition rise or fall rate	$V_{CC} = 3.3V \pm 0.3V$		10	ns/V
	1016	$V_{CC} = 5V \pm 0.5V$		5	
T _A	Operating free-air temperature		-40	125	°C

Notes: 3. Unused inputs should be held at Vcc or Ground.



SINGLE 3 INPUT POSITIVE NAND GATE

Electrical Characteristics $T_A = -40^{\circ}C$ to 85°C (All typical values are at $V_{CC} = 3.3V$, $T_A = 25^{\circ}C$)

Symbol	Parameter	Test Conditions	V _{CC}	Min	Тур.	Max	Unit
		I _{OH} = -100μA	1.65V to 5.5V	$V_{CC} - 0.1$			
		I _{OH} = -4mA	1.65V	1.2			
Maria	High Level Output	I _{OH} = -8mA	2.3V	1.9			V
V _{OH}	Voltage	I _{OH} = -16mA	- 3V	2.4			V
		I _{OH} = -24mA	30	2.3			
		I _{OH} = -32mA	4.5V	3.8			
		I _{OL} = 100μΑ	1.65V to 5.5V			0.1	
		I _{OL} = 4mA	1.65V			0.45	
N/		I _{OL} = 8mA	2.3V			0.3	V
V _{OL}	High-level Input Voltage	I _{OL} = 16mA	2)/			0.4	V
		I _{OL} = 24mA	- 3V			0.55	
		I _{OL} = 32mA	4.5V			0.55	
lj	Input Current	$V_1 = 5.5 V \text{ or GND}$	0 to 5.5V			± 5	μA
I _{OFF}	Power Down Leakage Current	$V_1 \text{ or } V_0 = 5.5 V$	0			± 10	μA
I _{CC}	Supply Current	V _I = 5.5V of GND I _O =0	1.65V to 5.5V			10	μA
ΔI _{CC}	Additional Supply Current	Input at V _{CC} –0.6V	3V to 5.5V			500	μA



SINGLE 3 INPUT POSITIVE NAND GATE

Electrical Characteristics $T_A = -40^{\circ}C$ to 125°C (All typical values are at $V_{CC} = 3.3V$, $T_A = 25^{\circ}C$)

Symbol	Parameter	Test Conditions	V _{cc}	Min	Тур.	Max	Unit
		I _{OH} = -100μA	1.65V to 5.5V	V _{CC} – 0.1			
		I _{OH} = -4mA	1.65V	0.95			
	High Level Output	I _{OH} = -8mA	2.3V	1.7			v
V _{OH}	Voltage	I _{OH} = -16mA	0)/	1.9			V
		I _{OH} = -24mA	- 3V	2.0			
		I _{OH} = -32mA	4.5V	3.4			
		I _{OL} = 100μA	1.65V to 5.5V			0.1	
		I _{OL} = 4mA	1.65V			0.70	
V	High lovel loout Valtage	I _{OL} = 8mA	2.3V			0.45	V
V _{OL}	High-level Input Voltage	I _{OL} = 16mA	- 3V			0.60	v
		$I_{OL} = 24mA$	30			0.80	
		I _{OL} = 32mA	4.5V			0.80	
l	Input Current	$V_I = 5.5 V \text{ or GND}$	0 to 5.5V			± 20	μA
I _{OFF}	Power Down Leakage Current	$V_{\rm I}$ or $V_{\rm O}$ = 5.5V	0			± 20	μA
I _{CC}	Supply Current	V _I = 5.5V of GND I _O =0	1.65V to 5.5V			40	μA
ΔI _{CC}	Additional Supply Current	Input at V _{CC} –0.6V	3V to 5.5V			5000	μΑ
Ci	Input Capacitance	$V_i = V_{CC} - or GND$	3.3		4		pF
		SOT26			204		
θ_{JA}	Thermal Resistance	SOT363	(Note 4)		371		°C/W
UJA	Junction-to-Ambient	DFN1410	(Note 4)		430		0/11
		DFN1010			510		
		SOT26			52		
$\theta_{\rm JC}$	Thermal Resistance	SOT363	(Note 4)		143		°C/M
OJC.	Junction-to-Case	DFN1410			190		°C/W
		DFN1010			250		

Package Characteristics (All typical values are at Vcc = 3.3V, T_A = 25°C)

Symbol	Parameter	Test Conditions	V _{CC}	Min	Тур.	Мах	Unit
CI	Input Capacitance	$V_I = V_{CC} - or GND$	3.3		3.5		pF
		SOT26			204		
	θ _{JA} Thermal Resistance Junction-to-Ambient	SOT363			371		0.0.00
θ_{JA}		DFN1410	(Note 4)		430		°C/W
		DFN1010			510		1
		SOT26			52		
0	Thermal Resistance	SOT363			143		0.0.0.4
θic	Junction-to-Case	DFN1410	(Note 4)		190		°C/W
		DFN1010]		250		

Notes: 4. Test condition for SOT26, SOT363, DFN1410 and DFN1010 : Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



SINGLE 3 INPUT POSITIVE NAND GATE

Switching Characteristics

T_{A} = -40°C to 85°C, CL = 15pF (see Figure 1)

Parameter	From (Input)		V _{CC} = 1.8V ± 0.15V		V _{CC} = 2.5V ± 0.2V		V _{CC} = 3.3V ± 0.3V		V _{CC} = 5V ± 0.5V		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Y	1.0	14.8	0.7	5.5	0.7	3.8	0.7	2.7	ns

$T_A = -40^{\circ}C \text{ to } 85^{\circ}C$, CL = 30 or 50pF (see Figure 2)

Parameter	From (Input)		V _{CC} = 1.8V ± 0.15V		V _{CC} = 2.5V ± 0.2V		V _{CC} = 3.3V ± 0.3V		V _{CC} = 5V ± 0.5V		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Y	1.0	18.0	0.7	6.5	0.7	5	0.7	3.6	ns

T_A = -40°C to 125°C, CL = 15 pF (see Figure 1)

Parameter	From (Input)	TO (OUTPUT)	V _{CC} = 1.8V ± 0.15V		V _{CC} = 2.5V ± 0.2V		V _{CC} = 3.3V ± 0.3V		V _{CC} = 5V ± 0.5V		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Y	1.0	17.7	0.7	6.6	0.7	4.6	0.7	3.3	ns

$\textbf{T}_{\textbf{A}}\textbf{=}\textbf{-40^{\circ}C} \text{ to } \textbf{125^{\circ}C}$, CL = 30 or 50 pF (see Figure 2)

Parameter	From (Input)	TO (OUTPUT)	V _{CC} = 1.8V ± 0.15V		V _{CC} = 2.5V ± 0.2V		V _{CC} = 3.3V ± 0.3V		V _{CC} = 5V ± 0.5V		Unit
	(input)	(0011 01)	Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Y	1.0	21.6	0.7	7.8	0.7	6.0	0.7	4.3	ns

Operating Characteristics

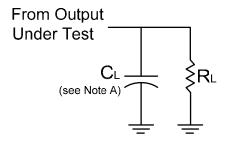
$T_A = 25 \ ^{o}C$

	Parameter Co		V _{CC} = 1.8V Typ.	V _{CC} = 2.5V Typ.	V _{CC} = 3.3V Typ.	V _{CC} = 5V Typ.	Unit
C _{pd}	Power dissipation capacitance	f = 10 MHz	17	18	19	22	pF



SINGLE 3 INPUT POSITIVE NAND GATE

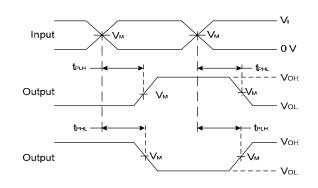
Parameter Measurement Information



V _{CC}	Inputs		V	C	Р
	VI	t _r /t _f	V _M	CL	RL
1.8V±0.15V	V _{CC}	≤2ns	V _{CC} /2	15pF	1MΩ
2.5V±0.2V	V _{CC}	≤2ns	V _{CC} /2	15pF	1ΜΩ
3.3V±0.3V	3V	≤2.5ns	1.5V	15pF	1ΜΩ
5V±0.5V	V _{CC}	≤2.5ns	V _{CC} /2	15pF	1ΜΩ



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1. Load Circuit and Voltage Waveforms

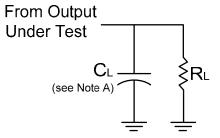
Notes:

- A. Includes test lead and test apparatus capacitance.
- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
- C. Inputs are measured separately one transition per measurement
- D. t_{PLH} and t_{PHL} are the same as t_{PD}

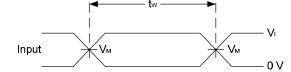


SINGLE 3 INPUT POSITIVE NAND GATE

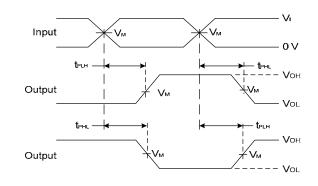
Parameter Measurement Information (cont.)



V _{CC}	Inputs		V	0	P
	VI	t _r /t _f	V _M	υL	RL
1.8V±0.15V	V _{CC}	≤2ns	V _{CC} /2	30pF	1ΚΩ
2.5V±0.2V	V _{CC}	≤2ns	V _{CC} /2	30pF	500Ω
3.3V±0.3V	3V	≤2.5ns	1.5V	50pF	500Ω
5V±0.5V	V _{CC}	≤2.5ns	V _{CC} /2	50pF	500Ω



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 2. Load Circuit and Voltage Waveforms

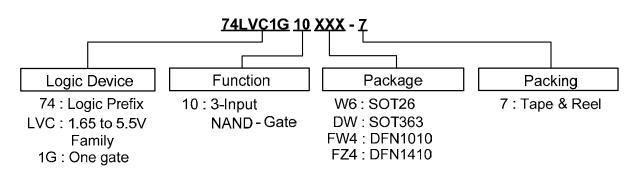
Notes: A . Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
- C. Inputs are measured separately one transition per measurement
- D. t_{PLH} and t_{PHL} are the same as t_{PD}



SINGLE 3 INPUT POSITIVE NAND GATE

Ordering Information



	Device	Package Packaging		7" Tape a	and Reel
	Device	Code	(Note 7)	Quantity	Part Number Suffix
Pb	74LVC1G10W6-7	W6	SOT26	3000/Tape & Reel	-7
Pb	74LVC1G10DW-7	DW	SOT363	3000/Tape & Reel	-7
Pb,	74LVC1G10FW4-7	FW4	DFN1010	5000/Tape & Reel	-7
P ,	74LVC1G10FZ4-7	FZ4	DFN1410	5000/Tape & Reel	-7

Notes:

 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

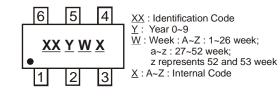
6. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf



SINGLE 3 INPUT POSITIVE NAND GATE

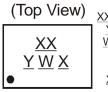
Marking Information

(1) SOT26, SOT363



Part Number	Package	Identification Code
74LVC1G10W6	SOT26	TU
74LVC1G10DW	SOT363	TU

(2) DFN1010, DFN1410



 $\begin{array}{l} \underline{XX}: \text{ Identification Code} \\ \underline{Y}: \ \text{Year } 0\-9 \\ \underline{W}: \ \text{Week}: \ A\-Z: 1\-26 \ \text{week}; \\ a\-z: 27\-52 \ \text{week}; \\ z \ \text{represents } 52 \ \text{and } 53 \ \text{week} \\ \underline{X}: \ A\-Z: \ \text{Internal Code} \end{array}$

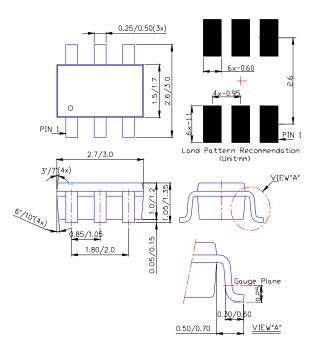
Part Number	Package	Identification Code
74LVC1G10FW4	DFN1010	TU
74LVC1G10FZ4	DFN1410	TU



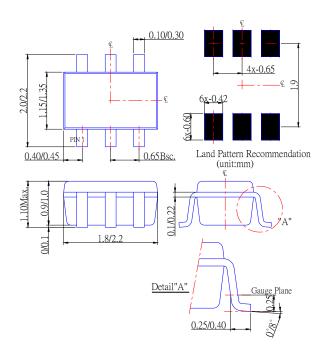
SINGLE 3 INPUT POSITIVE NAND GATE

Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: SOT26



(2) Package Type: SOT363

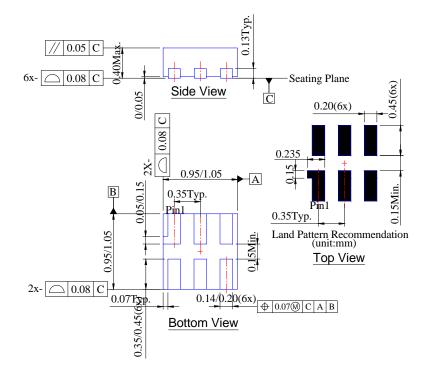




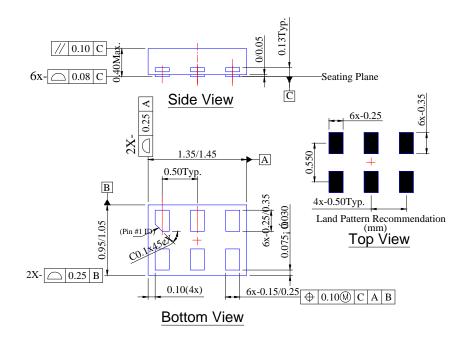
SINGLE 3 INPUT POSITIVE NAND GATE

Package Outline Dimensions (All Dimensions in mm)

(3) Package Type: DFN1010



(4) Package Type DFN1410





SINGLE 3 INPUT POSITIVE NAND GATE

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